Incorporating Cut Redistribution with Mask Assignment to Enable 1D Gridded Design

Jian Kuang, Evangeline F. Y. Young, Bei Yu



Outline

- <u>Background</u>
- Problem Formulation
- ILP
- Graph Model and Algorithm
- Post-processing
- Results and Conclusions

Lithography Technologies

- DPL (double patterning lithography)
 - One layout is decomposed into two masks
 - Litho-etch process is repeated twice
 - Resolution can be improved
 - Like 2-coloring



- EBL (e-beam lithography)
 - Directly creates features by electron beams w/o mask
 - Excellent resolution

Fabrication of 1D Layout

Line-end cuts



• Native conflict: Even redistribution plus DPL decomposition cannot solve the conflict. **Requires EBL.**



Resolving Conflicts between Cuts

- Three ways to resolve a conflict
 - DPL (coloring)



 Manufacture one cut by EBL <u>cost of EBL</u>





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Problem Definition

- Given a layout of *n* wires and *2n* cuts, decide the fabrication method (using EBL or not), the mask and the location of each cut, such that
 - All design rules are satisfied.
 - $wire_extension \leq limit$ for each wire
 - min. $\sum wire_extension + \partial \cdot EBL_cut \#$

Design Rules

- Wires can be extended but not shortened.
- No conflict between two cuts if they are merged.



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ILP

- Existing ILP [DAC'14] solves problem for EBL plus redistribution but no DPL considerations.
- Our contributions:
 - Analyze the potential problems in [DAC'14].
 - Show how to fix the problems.
 - Consider DPL besides EBL and redistribution.

[DAC'14] Ding et al. "Throughput optimization for SADP and e-beam based manufacturing of 1D layout", In Proc. DAC, 2014

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What is a "Move"?

- A move $(c_i, \pm d_i)$
 - Cut *c_i*
 - Right/Left: ±
 - Discrete moving distance d_i
 - Cost = Wire extension resulted



(*a*, -1): space *a* and *b* (*b*,+1): align *b* and *c* (*c*,+1): space *b* and *c*

Move Selection

- Select moves to change locations of cuts such that no odd cycle is created in conflict graph
 - No odd cycle \equiv 2-colorable



Select moves based on an integrated graph model
Obtained by integrating *G*₁, *G*₂ and *G*₃

Graph Model 1

• G_I : constraint graph for move operations:



- Two moves are incompatible (have an edge) if
 - Exceed limit on wire extension, or
 - Both shift a cut in different directions, or
 - Applying both cannot resolve the targeted conflicts

Graph Model 2

• G_2 is a bipartite graph between conflicts and moves:



e.g. Moving a to the left 1 step (m_1) can resolve the conflict between (a,c) and m_1 . Thus there is an edge between (a,c) and m_1 .

Graph Model 3

 G_3 : bipartite graph between conflicts and odd cycles



- The edge between cl_0 and (a,c) means that resolving conflict (a,c) can break odd cycle cl_0 .
- All odd cycles should be broken.
- Number of odd cycles can be exponential.
 - Only consider odd cycles in a cycle basis a set of cycles that can be combined to form every cycle in a graph.

Integrated Graph Model



- Constraints between moves (dash lines) are copied.
- cl_0 —(a,c) in G₃ and (a,c)— m_1 in G₂ gives cl_0 — m_1 in the final graph meaning that move m_1 can break cycle cl_0 .

Move Selection by Constrained Set Cover

- Select moves to break all the identified odd cycles
- Constrained set cover problem:
- Select a set of min-cost moves to break all cycles under some constraints.



Solving Constrained Set Cover

- Use ILP to solve the constrained set cover problem:
 - Constant a_{ij} indicates if an edge exists btw. cycle *i* and move m_j
 - Variable b_j indicates if move m_j is selected





 $b_i + b_j \le 1$, \forall move m_i incompatible with m_j

 Much smaller and simpler than the ILP solving the original problem directly.

EBL Cut Selection

Flow (Review)

do

Select some moves. Perform selected moves. Rebuild conflict graph. **until** all cuts 2-colorable **or** no moves are available.

Select some cuts as EBL cuts.

- When a cut is an EBL cut, its corresponding node is deleted from the conflict graph.
- Problem: Delete a minimum number of nodes from the conflict graph such that at least one node will be deleted from each cycle in a cycle basis.
- Solution: Use a similar ILP without incompatible constraints

Accelerating by Potential Conflict Graph

• <u>Conflict graph</u> *G* of cuts:

Conflicts between cuts can change dynamically if cuts can move.

• Potential conflict graph G_p .

An edge between two nodes iff there is a potential conflict between the two cuts with cut redistribution

G_p is stable and can be safely split into sub-layouts to reduce problem size





Handling Vertically Aligned Cuts

- #cut=2: a and b never conflict
 - As we can merge them if $\operatorname{color}(a) = \operatorname{color}(b)$
- #cut=3: no conflict if color(b) = color(a) or color(c)
 - Conflict edge *a*—*c* : unnecessary
- # vertically aligned cuts = n ≤ H+1:
 (*H* is the largest difference between two conflicting track labels.)
- Lemma: No conflict iff $\exists i \text{ for } 2 \leq i \leq n \text{ s.t. } c_1 \dots c_{i-1}$ are colored the same and $c_i \dots c_n$ are colored the same.
- Grouping nodes instead of adding many edges $\begin{array}{c} a \circ \\ b \circ \end{array}$ in conflict graph



|a|

DPL+EBL

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Post-processing methods

- Objective: To minimize wire extensions.
- Globally: Longest-path algorithm:
 - Compact the cuts at <u>right</u> ends of wires to the <u>left</u>
 - Compact the cuts at <u>left</u> ends of wires to the <u>right</u>



Locally: Greedily shift cuts towards their original locations

Longest Path algorithm

• For those right end cuts, construct a left compaction



- Edge cost:
 - *s* to node: Leftmost *x* of the movable range of the cut.
 - Between nodes: Required distance between the 2 nodes.
- Edge direction:
 - b to a iff $x_a > x_b$
- Distance of the longest path from *s* to *i*:
 - Leftmost *x* to place *i*

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Comparison with ILP

Dataset	Optimal ILP			Ours		
Track#	EBL#	Extension	Time(s)	EBL#	Extension	Time(s)
50	0	26	18.0	0	26	0.1
100	0	46	180.4	0	46	0.2
150	0	78	6446.9	0	79	0.4
200	-	-	>36000	0	104	0.5
250	-	-	>36000	0	129	0.6
300	-	-	>36000	0	164	0.7
1000	-	-	>36000	0	583	2.2
2000	-	-	>36000	0	1230	4.5
4000	-	-	>36000	1	2500	9.4
8000	-	-	>36000	1	5178	18.8

• ILP is too slow.

Caused by native conflict

- Our EBL# has achieved lower bound for all datasets.
- Our quality is very close to ILP if ILP has solutions.

Comparison with

Optimal Coloring + Optimal Redistribution

Dataset	Opt. color + redistribute		Ours		
Track#	Cost	Time (s)	Cost	Time (s)	
50	4029	0.7	26	0.1	
100	9050	1.2	46	0.2	
150	14091	2.4	79	0.4	
200	17109	2.8	104	0.5	
250	19135	3.4	129	0.6	
300	23174	4.7	164	0.7	
1000	69670	35.6	583	2.2	
2000	132380	91.4	1230	4.5	
4000	280764	245.3	3500	9.4	
8000	573740	2784.9	6178	18.8	
Ratio	95.0	84.8	1	1	

- Our algorithm optimizes coloring and redistribution simultaneously
- Cost = $\sum wire_extension + \partial \cdot EBL_cut# = \partial = 100$

Conclusion

- Co-optimization of cut redistribution and mask assignment for 1D gridded design.
- Novel graph-theoretic method that makes use of integrated graph model + longest path-based refinement
- 1D design is the future of 10nm technology node and beyond and more research can be done.